

## 1. Product Features

### 1.1 Electrical features

- $V_{CES}=650V$
- $I_{C\ nom}=100A / I_{CRM}=200A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- Integrated NTC temperature sensor
- High power and thermal cycling capability



Figure 1 IGBT Module

### 1.2 Mechanical features

- $Al_2O_3$  substrate with low thermal resistance
- Copper base plate

## 2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

## 3. Description

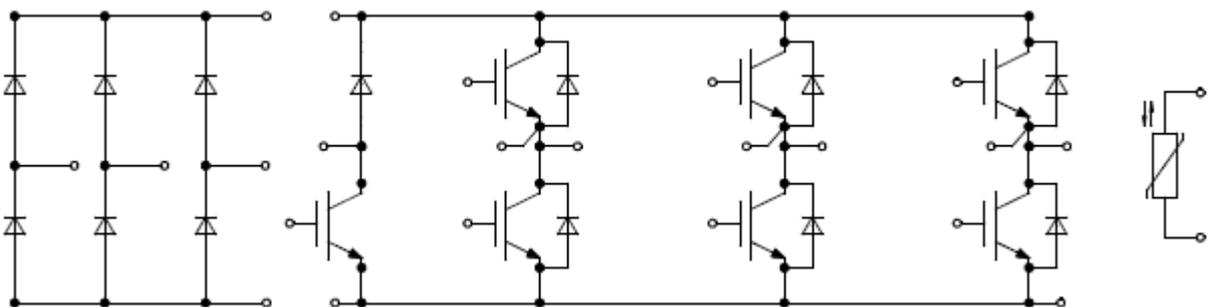


Figure 2 3 Phase Bridge +Rectifier+Brake

## 4. IGBT, Inverter

### 4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	650	V
Continuous DC collector current 连续集电极电流	$T_C = 105^{\circ}\text{C}, T_{vj\text{ max}} = 150^{\circ}\text{C}$	$I_{C\text{ nom}}$	100	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1\text{ ms}$	$I_{CRM}$	200	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj\text{ max}} = 175^{\circ}\text{C}$	$P_{\text{tot}}$	436	W
Gate-emitter peak voltage 栅极—发射极峰值电压		$V_{GES}$	+/- 20	V

### 4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 100\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$		1.19		V
		$T_{vj} = 125^{\circ}\text{C}$		1.22		V
		$T_{vj} = 150^{\circ}\text{C}$		1.23		V
Gate threshold voltage 栅极阈值电压	$I_C = 1.5\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE,\text{th}}$	5.0	5.7	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15\text{ V} \dots +15\text{ V}$	$Q_G$		0.48		$\mu\text{C}$
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	$R_{G\text{int}}$		2.60		$\Omega$
Input capacitance 输入电容	$f=1\text{ MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$C_{\text{ies}}$		8.92		nF
Reverse transfer capacitance 反向传输电容	$f=1\text{ MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$C_{\text{res}}$		0.07		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{CES}$			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$			100	nA

(table continues...) 待续

Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Turn-on delay time, inductive load 开通延迟时间	$I_C = 100A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,on} = 4.7\Omega$	$T_{vj} = 25^\circ C$	$t_{d,on}$		0.06		us
		$T_{vj} = 125^\circ C$			0.07		us
		$T_{vj} = 150^\circ C$			0.07		us
Rise time, inductive load 上升时间	$I_C = 100A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,on} = 4.7\Omega$	$T_{vj} = 25^\circ C$	$t_r$		0.03		us
		$T_{vj} = 125^\circ C$			0.03		us
		$T_{vj} = 150^\circ C$			0.03		us
Turn-off delay time, inductive load 关断延迟时间	$I_C = 100A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,off} = 4.7\Omega$	$T_{vj} = 25^\circ C$	$t_{d,off}$		0.11		us
		$T_{vj} = 125^\circ C$			0.13		us
		$T_{vj} = 150^\circ C$			0.13		us
Fall time, inductive load 下降时间	$I_C = 100A, V_{CE} = 300V$ $V_{GE} = +15/-15V$ $R_{G,off} = 4.7\Omega$	$T_{vj} = 25^\circ C$	$t_f$		0.03		us
		$T_{vj} = 125^\circ C$			0.04		us
		$T_{vj} = 150^\circ C$			0.05		us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 100A, V_{CE} = 300V, L_s = 30nH$ $V_{GE} = +15/-15V, di/dt = 2705A/\mu s$ $R_{G,on} = 4.7\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$	$E_{on}$		0.51		mJ
		$T_{vj} = 125^\circ C$			1.42		mJ
		$T_{vj} = 150^\circ C$			1.33		mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 100A, V_{CE} = 300V, L_s = 30nH$ $V_{GE} = +15/-15V, dv/dt = 6115V/\mu s$ $R_{G,off} = 4.7\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$	$E_{off}$		1.10		mJ
		$T_{vj} = 125^\circ C$			1.41		mJ
		$T_{vj} = 150^\circ C$			1.49		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 360V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$		$I_{sc}$		700		A
Thermal resistance, junction to case 结-散热器热阻	Per IGBT		$R_{th,jc}$			0.34	K/W

## 5. Diode, Inverter

### 5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	650	V
Continuous DC forward current 连续正向直流电流		$I_F$	100	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1 \text{ ms}$	$I_{FRM}$	200	A

### 5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$	$V_F$		$T_{vj} = 25^{\circ}\text{C}$	1.61	V
				$T_{vj} = 125^{\circ}\text{C}$	1.41	V
				$T_{vj} = 150^{\circ}\text{C}$	1.36	V
Peak reverse recovery current 反向恢复峰值电流	$I_F = 100 \text{ A}, V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}, -di_F/dt = 3430 \text{ A}/\mu\text{s}$ $R_{G,on} = 4.7\Omega (T_{vj} = 150^{\circ}\text{C})$	$I_{RM}$		$T_{vj} = 25^{\circ}\text{C}$	92.2	A
				$T_{vj} = 125^{\circ}\text{C}$	132	A
				$T_{vj} = 150^{\circ}\text{C}$	141	A
Recovered charge 恢复电荷	$I_F = 100 \text{ A}, V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}, -di_F/dt = 3430 \text{ A}/\mu\text{s}$ $R_{G,on} = 4.7\Omega (T_{vj} = 150^{\circ}\text{C})$	$Q_r$		$T_{vj} = 25^{\circ}\text{C}$	3.21	$\mu\text{C}$
				$T_{vj} = 125^{\circ}\text{C}$	6.78	$\mu\text{C}$
				$T_{vj} = 150^{\circ}\text{C}$	7.83	$\mu\text{C}$
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 100 \text{ A}, V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}, -di_F/dt = 3430 \text{ A}/\mu\text{s}$ $R_{G,on} = 4.7\Omega (T_{vj} = 150^{\circ}\text{C})$	$E_{rec}$		$T_{vj} = 25^{\circ}\text{C}$	0.43	mJ
				$T_{vj} = 125^{\circ}\text{C}$	1.05	mJ
				$T_{vj} = 150^{\circ}\text{C}$	1.25	mJ
Thermal resistance, junction to case 结-散热器热阻	Per diode	$R_{th,jc}$			0.84	K/W

## 6. Diode, Rectifier

### 6.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	1600	V
Average Rectified Output current 整流器输出均方根电流	$V_F = 1.2, T_{vj} = 150^{\circ}\text{C}$	$I_F$	100	A
Surge forward current 正向浪涌电流	$t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I_{FSM}$	990	A
$I^2t$ - value $I^2t$ -值	$t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I^2t$	4950	$\text{A}^2\text{s}$

### 6.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$T_{vj} = 150^{\circ}\text{C}, I_F = 100 \text{ A}$	$V_F$		1.15		V
Reverse current 反向电流	$T_{vj} = 150^{\circ}\text{C}, V_R = 1600 \text{ V}$	$I_R$		1		mA
Thermal resistance, junction to case 结—散热器热阻	Per diode	$R_{thJC}$			0.39	K/W

## 7. IGBT, Brake-Chopper

### 7.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	650	V
Continuous DC collector current 连续集电极电流	$T_C = 55^{\circ}\text{C}, T_{vj \text{ max}} = 150^{\circ}\text{C}$	$I_{C \text{ nom}}$	75	A
Repetitive peak collector current 集电极峰值电流	$t_p = 1 \text{ ms}$	$I_{CRM}$	150	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj \text{ max}} = 175^{\circ}\text{C}$	$P_{tot}$	230	W
Gate-emitter peak voltage 栅极—发射极峰值电压		$V_{GES}$	+/- 20	V

## 7.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极-发射极饱和电压	$I_C = 75\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.67		V
		$T_{vj} = 125^\circ\text{C}$		1.87		V
		$T_{vj} = 150^\circ\text{C}$		1.94		V
Gate threshold voltage 栅极阈值电压	$I_C = 1\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	$V_{GE,th}$	4.8	5.5	6.2	V
Gate charge 栅极电荷	$V_{GE} = -15\text{ V} \dots +15\text{ V}$	$Q_G$		0.15		$\mu\text{C}$
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^\circ\text{C}$	$R_{Gint}$		2.20		$\Omega$
Input capacitance 输入电容	$f=1\text{ MHz}, T_{vj}=25^\circ\text{C}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$C_{ies}$		3.93		nF
Reverse transfer capacitance 反向传输电容	$f=1\text{ MHz}, T_{vj}=25^\circ\text{C}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$C_{res}$		0.04		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^\circ\text{C}$	$I_{CES}$			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^\circ\text{C}$	$I_{GES}$			100	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 75\text{ A}, V_{CE} = 300\text{ V}$ $V_{GE} = +15/-15\text{ V}$ $R_{G,on} = 5.8\Omega$	$T_{vj} = 25^\circ\text{C}$		0.03		$\mu\text{s}$
		$T_{vj} = 125^\circ\text{C}$		0.03		$\mu\text{s}$
		$T_{vj} = 150^\circ\text{C}$		0.03		$\mu\text{s}$
Rise time, inductive load 上升时间	$I_C = 75\text{ A}, V_{CE} = 300\text{ V}$ $V_{GE} = +15/-15\text{ V}$ $R_{G,on} = 5.8\Omega$	$T_{vj} = 25^\circ\text{C}$		0.03		$\mu\text{s}$
		$T_{vj} = 125^\circ\text{C}$		0.03		$\mu\text{s}$
		$T_{vj} = 150^\circ\text{C}$		0.03		$\mu\text{s}$
Turn-off delay time, inductive load 关断延迟时间	$I_C = 75\text{ A}, V_{CE} = 300\text{ V}$ $V_{GE} = +15/-15\text{ V}$ $R_{G,off} = 5.8\Omega$	$T_{vj} = 25^\circ\text{C}$		0.08		$\mu\text{s}$
		$T_{vj} = 125^\circ\text{C}$		0.10		$\mu\text{s}$
		$T_{vj} = 150^\circ\text{C}$		0.10		$\mu\text{s}$
Fall time, inductive load 下降时间	$I_C = 75\text{ A}, V_{CE} = 300\text{ V}$ $V_{GE} = +15/-15\text{ V}$ $R_{G,off} = 5.8\Omega$	$T_{vj} = 25^\circ\text{C}$		0.04		$\mu\text{s}$
		$T_{vj} = 125^\circ\text{C}$		0.12		$\mu\text{s}$
		$T_{vj} = 150^\circ\text{C}$		0.13		$\mu\text{s}$
Turn-on energy loss per pulse 开通损耗能量	$I_C = 75\text{ A}, V_{CE} = 300\text{ V}, L_s=30\text{ nH}$ $V_{GE} = +15/-15\text{ V}, di/dt=2011\text{ A}/\mu\text{s}$ $R_{G,on} = 5.8\Omega (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		0.85		mJ
		$T_{vj} = 125^\circ\text{C}$		1.33		mJ
		$T_{vj} = 150^\circ\text{C}$		1.45		mJ

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy loss per pulse 关断损耗能量	$I_C = 75A, V_{CE} = 300V, L_S = 30nH$	$T_{vj} = 25^\circ C$		0.96		mJ
	$V_{GE} = +15V/-15V, dv/dt = 7422A/\mu s$	$T_{vj} = 125^\circ C$	$E_{off}$	1.47		mJ
	$R_{G,off} = 5.8\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		1.55		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 300V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$	$I_{sc}$		375		A
Thermal resistance, junction to case 结-散热器热阻	Per IGBT	$R_{th,Jc}$			0.65	K/W

## 8. Diode, Brake-Chopper

### 8.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	$V_{RRM}$	650	V
Continuous DC forward current 连续正向直流电流		$I_F$	50	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1ms$	$I_{FRM}$	100	A

### 8.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 50A, V_{GE} = 0V$	$T_{vj} = 25^\circ C$		1.47		V
		$T_{vj} = 125^\circ C$	$V_F$	1.24		V
		$T_{vj} = 150^\circ C$		1.18		V
Peak reverse recovery current 反向恢复峰值电流	$I_F = 50A, V_R = 300V$ $V_{GE} = -15V, -di_F/dt = 2154A/\mu s$ $R_{G,on} = 5.8\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		51.9		A
		$T_{vj} = 125^\circ C$	$I_{RM}$	76.6		A
		$T_{vj} = 150^\circ C$		83		A
Recovered charge 恢复电荷	$I_F = 50A, V_R = 300V$ $V_{GE} = -15V, -di_F/dt = 2154A/\mu s$ $R_{G,on} = 5.8\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		1.71		$\mu C$
		$T_{vj} = 125^\circ C$	$Q_r$	4.57		$\mu C$
		$T_{vj} = 150^\circ C$		4.65		$\mu C$

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 50A, V_R = 300V$	$E_{rec}$		0.33		mJ
	$V_{GE} = -15V, -di_F/dt = 2154 A/\mu s$			0.36	mJ	
	$R_{G,on} = 5.8\Omega (T_{vj} = 150^\circ C)$			0.97	mJ	
Thermal resistance, junction to case 结-散热器热阻	Per diode	$R_{th,Jc}$			0.92	K/W

## 9. NTC-Thermistor

### 9.1 Characteristic value

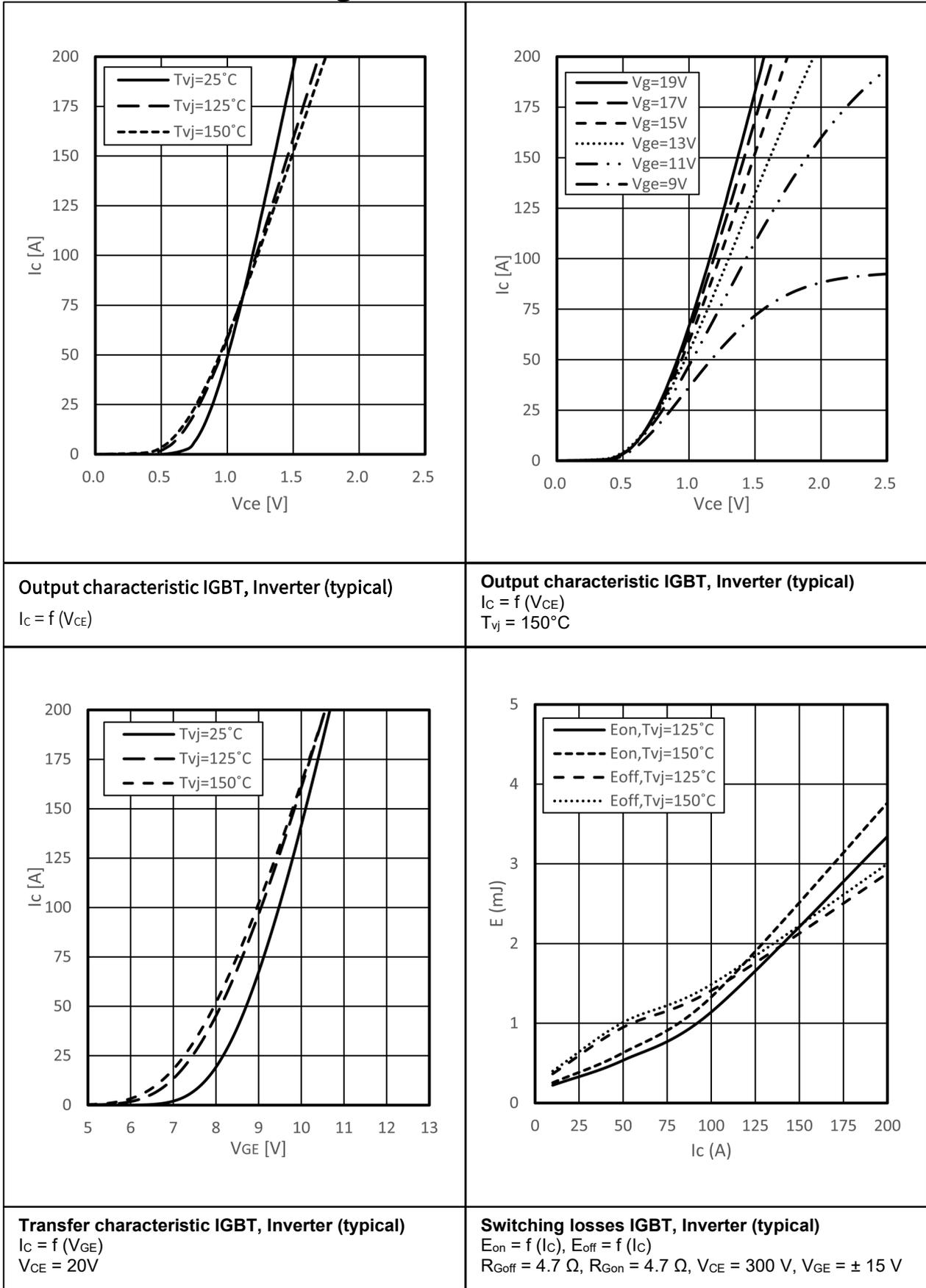
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance 额定电阻值	$T_c = 25^\circ C$	$R_{25}$		5.00		K $\Omega$
Power dissipation 耗散功耗	$T_c = 25^\circ C$	$P_{25}$			20	mW
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298, 15K))]$	$B_{25}/B_{50}$		3375		
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298, 15K))]$	$B_{25}/B_{75}$		3408		
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298, 15K))]$	$B_{25}/B_{100}$		3435		

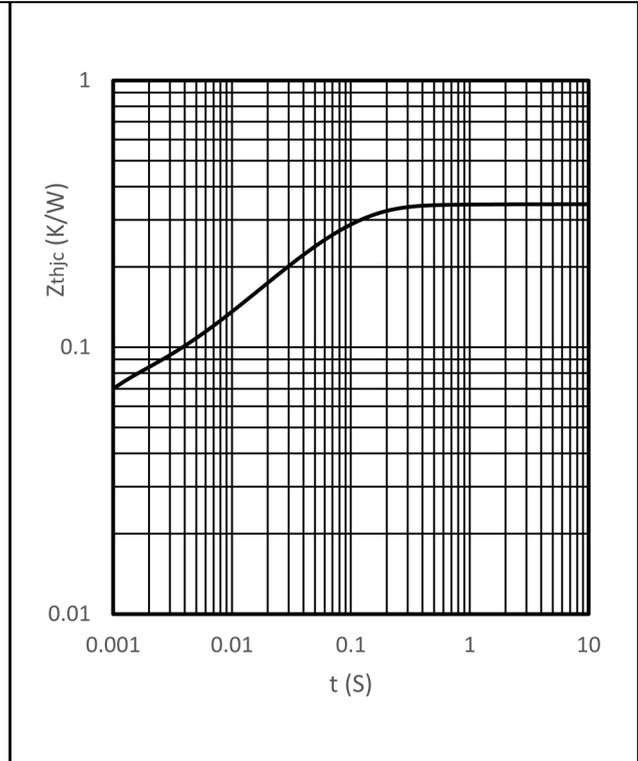
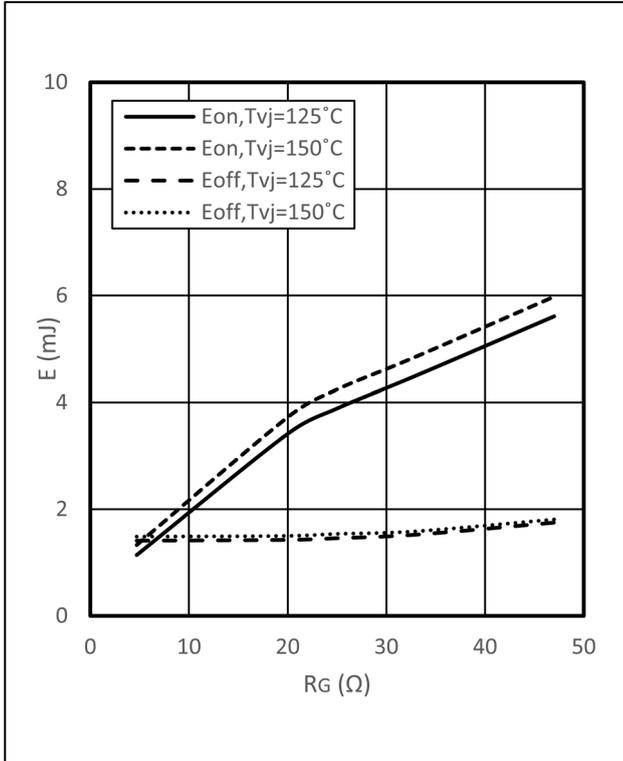
## 10. Module

### 10.1 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, $f=50HZ, 1min$	$V_{ISOL}$			2500	V
Stray inductance module 杂散电感		$L_{sCE}$		25		nH
Operation Junction Temperature 结温		$T_{jop}$	-40		150	$^\circ C$
Storage Temperature Range 存储温度范围		$T_{stg}$	-40		125	$^\circ C$
Mounting Torque 安装扭矩	Screw M5	M	3		6	N.m
Weight of Module 重量		G		300		g

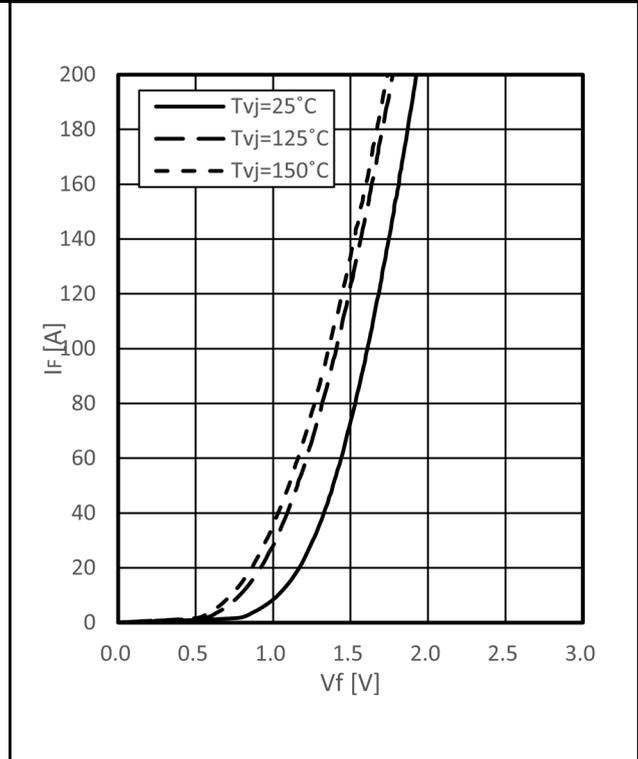
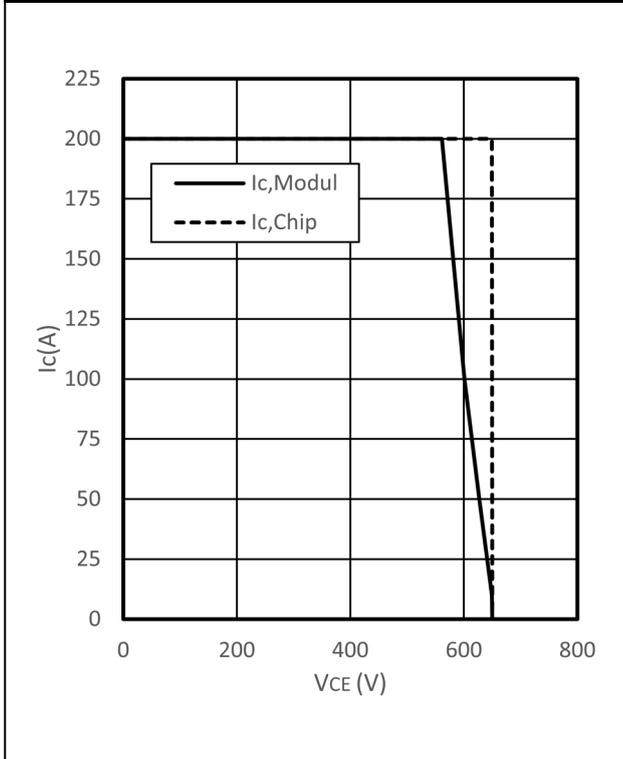
## 11. Characteristics diagrams





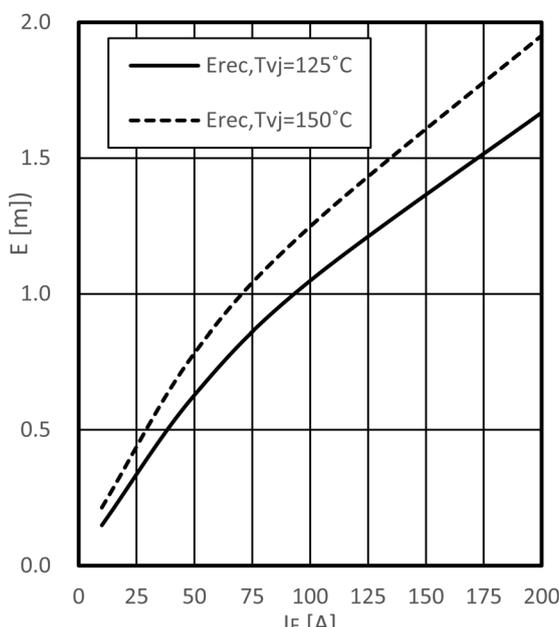
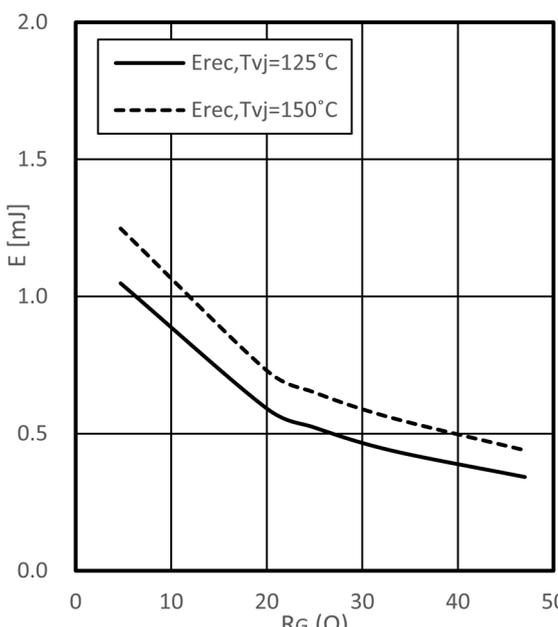
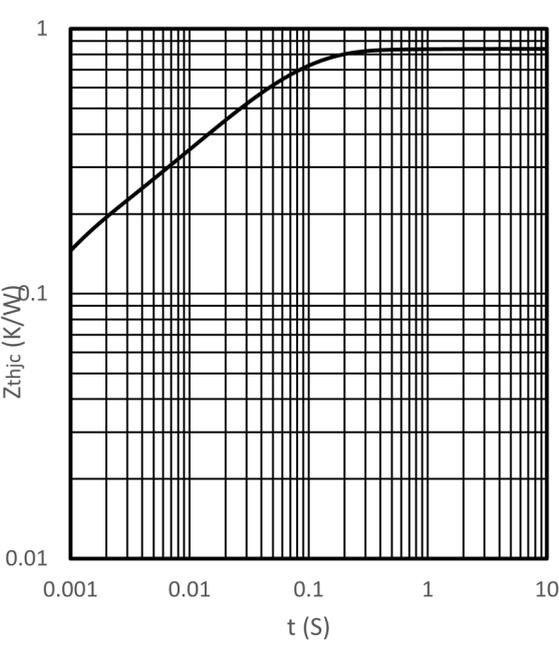
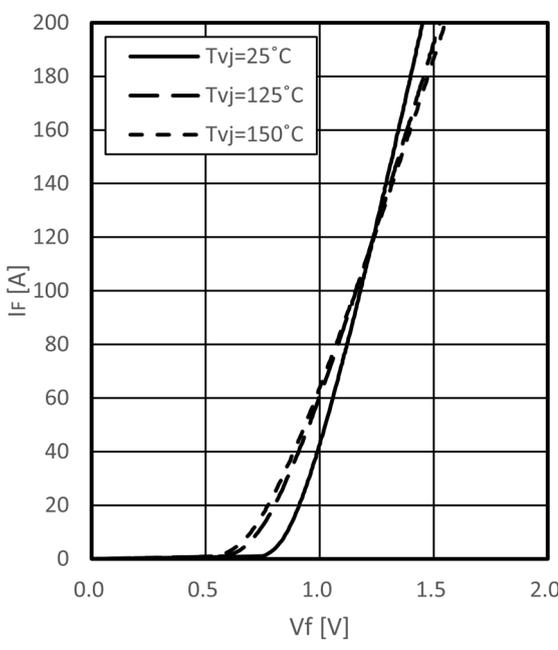
**Switching losses IGBT, Inverter (typical)**  
 $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $I_C = 200\text{ A}$ ,  $V_{CE} = 300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$

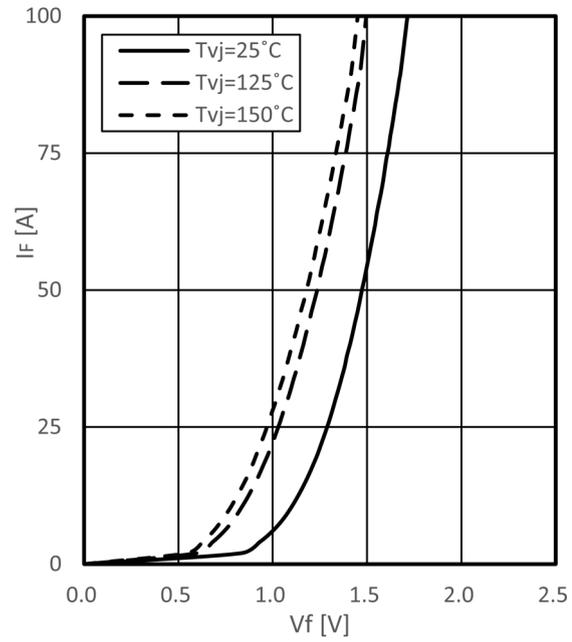
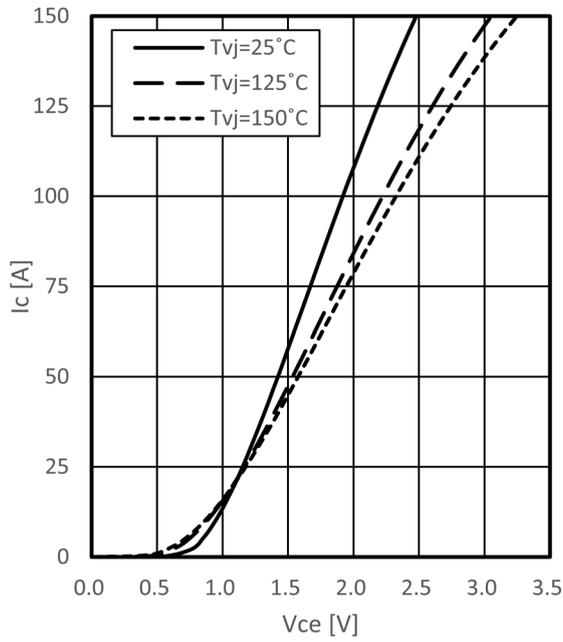
**Transient thermal impedance IGBT, Inverter**  
 $Z_{thjc} = f(t)$



**Reverse bias safe operating area IGBT, Inverter (RBSOA)**  
 $I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$ ,  $R_{Goff} = 4.7\ \Omega$ ,  $T_{vj} = 150^\circ\text{C}$

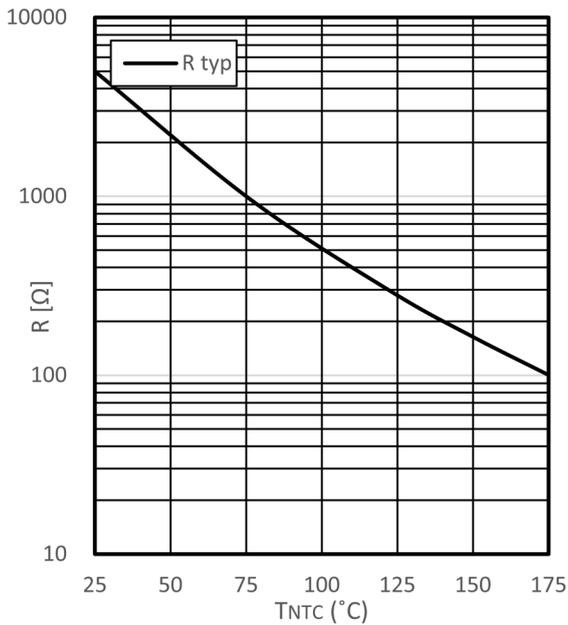
**Forward characteristic of Diode, Inverter (typical)**  
 $I_F = f(V_F)$

	
<p><b>Switching losses Diode, Inverter (typical)</b>  <math>E_{rec} = f(I_F)</math>  <math>R_{Gon} = 4.7 \Omega, V_{CE} = 300 V</math></p>	<p><b>Switching losses Diode, Inverter (typical)</b>  <math>E_{rec} = f(R_G)</math>  <math>I_F = 100 A, V_{CE} = 300 V</math></p>
	
<p><b>Transient thermal impedance Diode, Inverter</b>  <math>Z_{thjC} = f(t)</math></p>	<p><b>Forward characteristic of Diode, Rectifier (typical)</b>  <math>I_F = f(V_F)</math></p>



**Output characteristic IGBT, Brake-Chopper (typical)**  
 $I_c = f(V_{CE})$   
 $V_{GE} = 15V$

**Forward characteristic of Diode, Brake-Chopper (typical)**  
 $I_F = f(V_F)$



**NTC-Thermistor-temperature characteristic (typical)**  
 $R = f(T_{NTC})$

## 12. Circuit Diagram

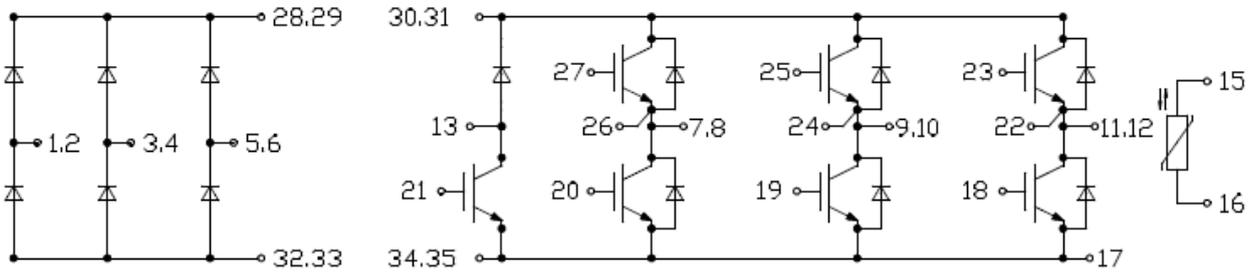


Figure 3

## 13. Package Outlines

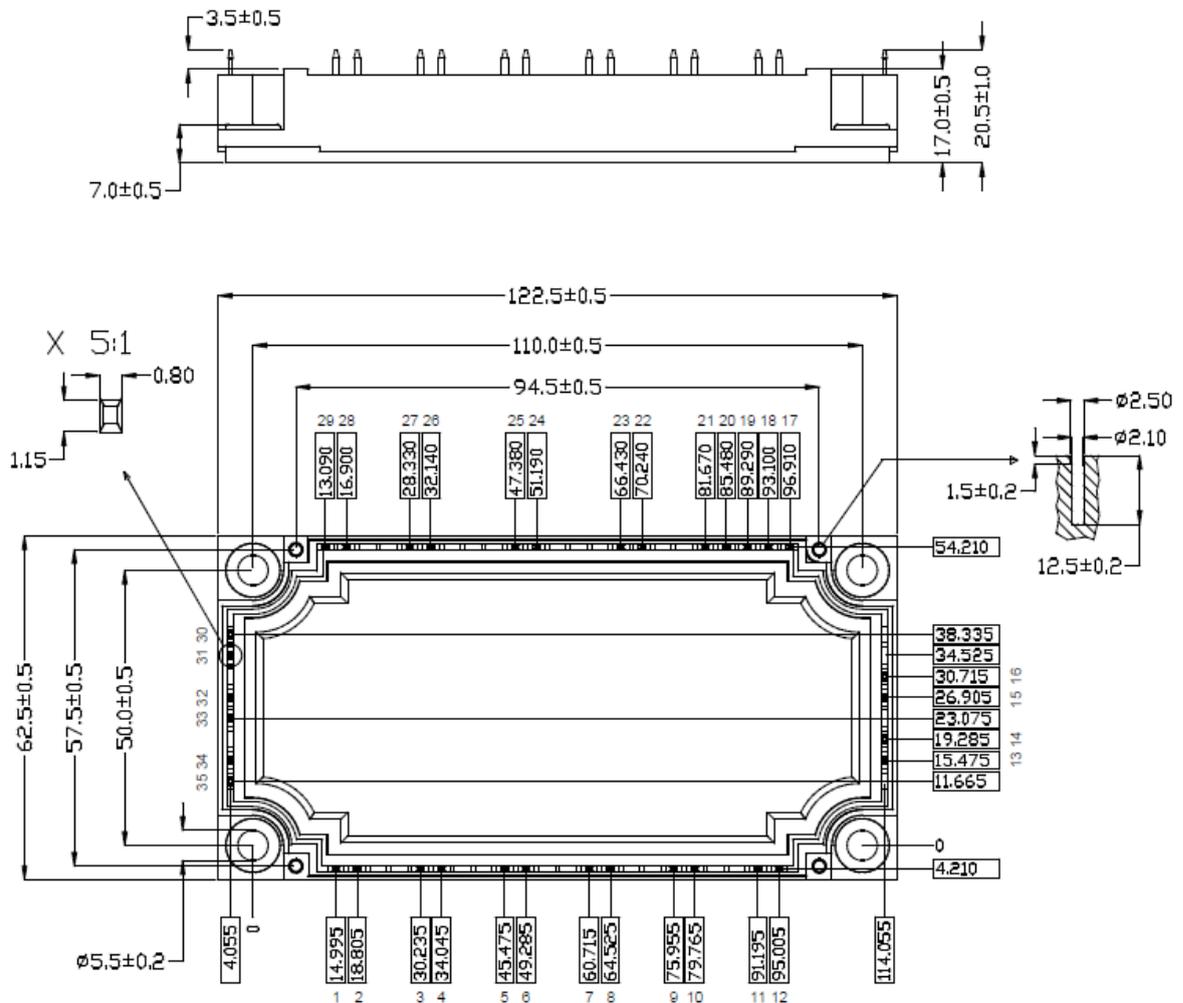


Figure 4